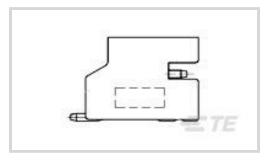


HPI

TE Internal #: 1-1775469-2 PCB Mount Header, Right Angle, Wire-to-Board, 12 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal, Natural, HPI

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Connector System: Wire-to-Board

Number of Positions: 12

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Right Angle

All AMP HPI 2.0 mm Headers (206)

Features

Product Type Features

Connector System

Header Type

Wire-to-Board

Fully Shrouded



| Sealable | No |
|-----------------------------------|-----------------------|
| Connector & Contact Terminates To | Printed Circuit Board |
| PCB Connector Assembly Type | PCB Mount Header |
| Configuration Features | |
| Number of Positions | 12 |
| Number of Rows | 1 |
| PCB Mount Orientation | Right Angle |
| Electrical Characteristics | |
| Operating Voltage | 250 VAC |
| Body Features | |
| Primary Product Color | Natural |
| Contact Features | |
| Contact Mating Area Length | 3.53 mm[.139 in] |
| Mating Square Post Dimension | .5 mm[.02 in] |
| | |

PCB Mount Header, Right Angle, Wire-to-Board, 12 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal, Natural, HPI



| PCB Contact Termination Area Plating Material Thickness | 2 µm[80 µin] |
|---|---------------------------|
| Contact Layout | Inline |
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Shape & Form | Square |
| Contact Mating Area Plating Material Finish | Matte |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Nickel |
| Contact Base Material | Brass |
| Contact Mating Area Plating Material | Tin |
| Contact Type | Pin |
| Contact Current Rating (Max) | 3 A |
| Termination Features | |
| Square Termination Post & Tail Dimension | .5 mm[.02 in] |
| Termination Post & Tail Length | 1 mm[.039 in] |
| Termination Method to Printed Circuit Board | Surface Mount |
| Mechanical Attachment | |
| Mating Alignment Type | Polarization |
| Mating Retention | Without |
| PCB Mount Retention Type | Solder Peg |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | With |
| Housing Features | |
| Housing Material | PA 9T GF |
| Centerline (Pitch) | 2 mm[.079 in] |
| Dimensions | |
| Connector Length | 27.4 mm[1.079 in] |
| Connector Height | 5.5 mm[.217 in] |
| Connector Width | 7.6 mm[.299 in] |
| Usage Conditions | |
| Operating Temperature Range | -25 – 85 °C[-13 – 185 °F] |
| | |

PCB Mount Header, Right Angle, Wire-to-Board, 12 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal, Natural, HPI



| Operation/Application | |
|--|------------------------|
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Quantity | 600 |
| Packaging Type | Reel |
| Product Compliance | |
| Product Compliance For compliance documentation, visit the product page on TE.com> | |
| • | Compliant |
| For compliance documentation, visit the product page on TE.com> | Compliant Compliant |
| For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU | |
| For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC | Compliant |

ppm.

Solder Process Capability

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

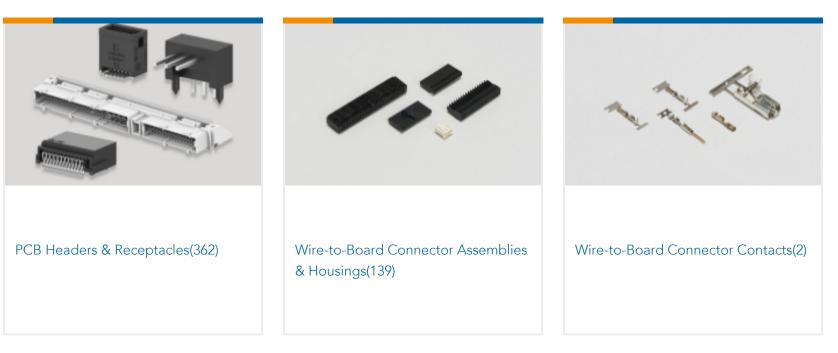
Compatible Parts

PCB Mount Header, Right Angle, Wire-to-Board, 12 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal, Natural, HPI

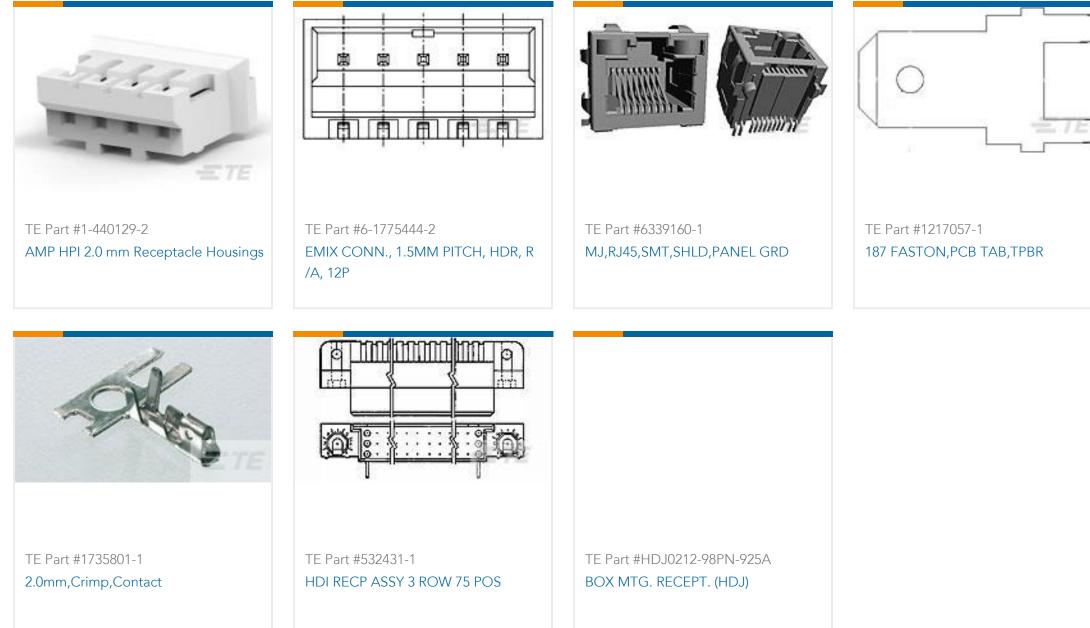


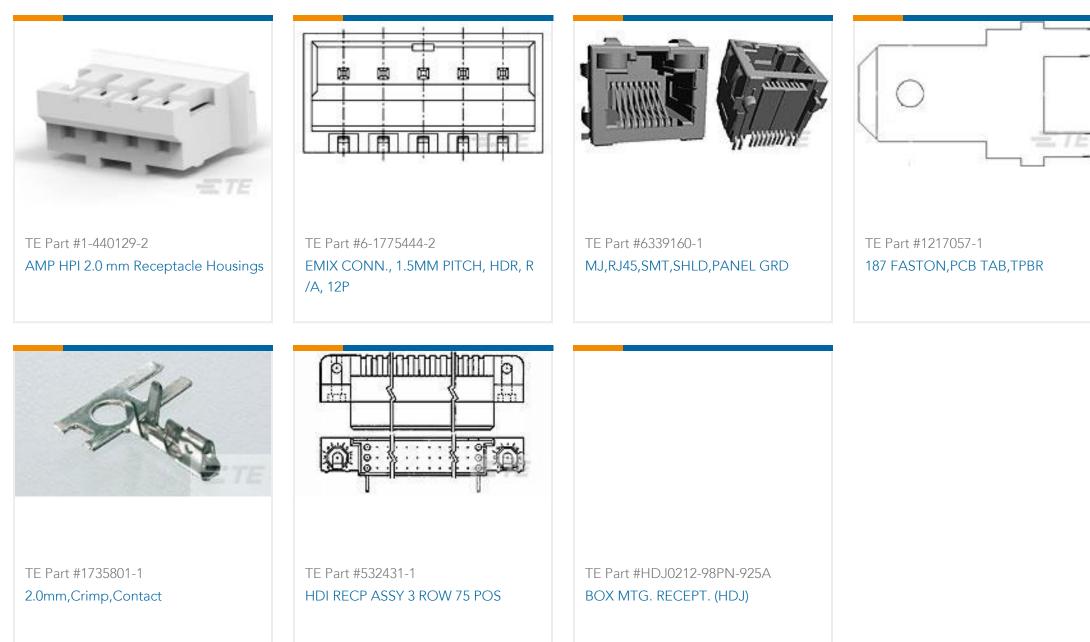


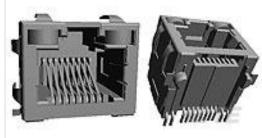
Also in the Series HPI

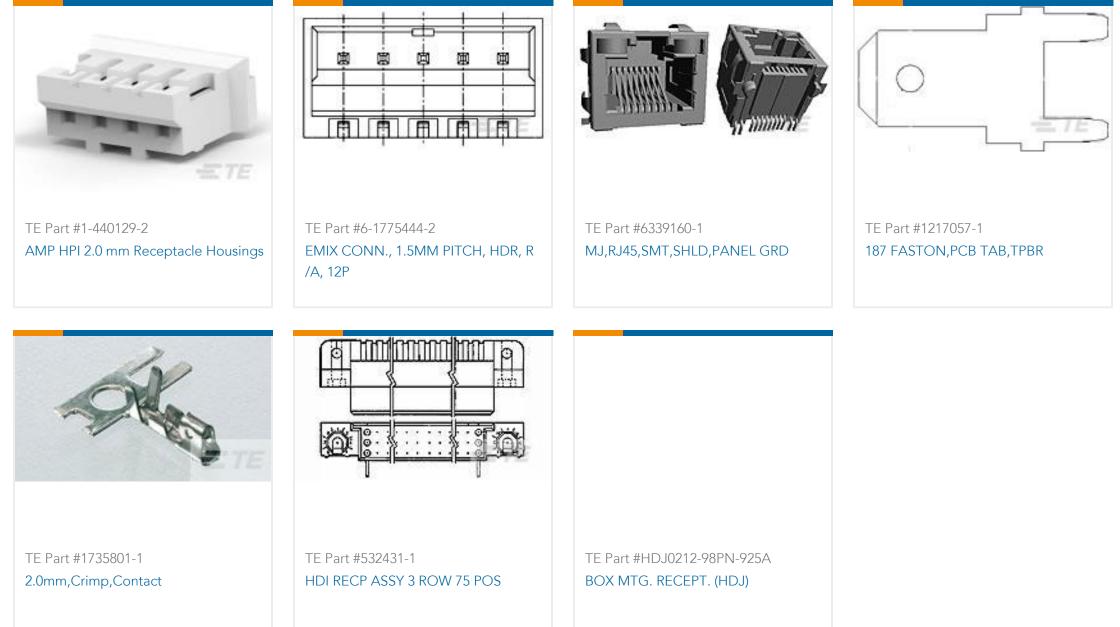


Customers Also Bought









Documents

CAD Files

Customer View Model

ENG_CVM_CVM_1-1775469-2_A.2d_dxf.zip

English

3D PDF

3D

PCB Mount Header, Right Angle, Wire-to-Board, 12 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal, Natural, HPI



Customer View Model

ENG_CVM_CVM_1-1775469-2_A.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_1-1775469-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Datasheets & Catalog Pages

HPI Connectors QRG

English

Product Specifications

Application Specification

English

Agency Approvals UL Report

English